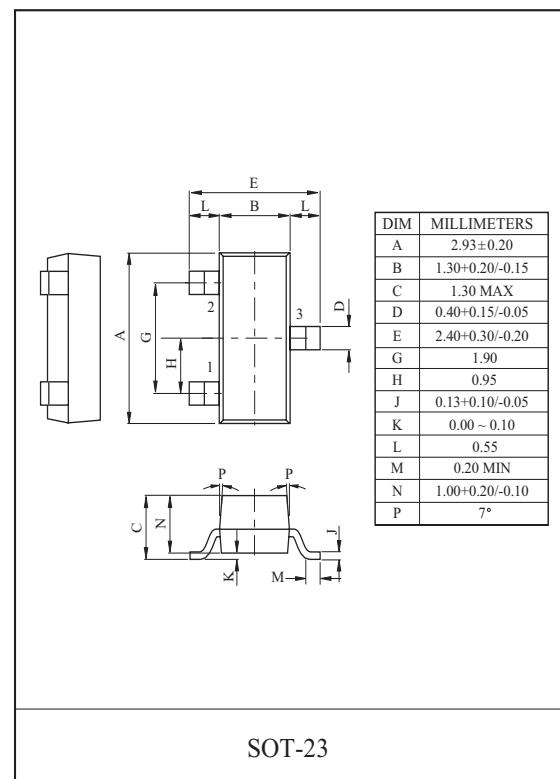


General Description

This Trench MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for portable equipment.

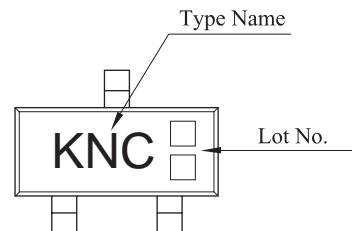
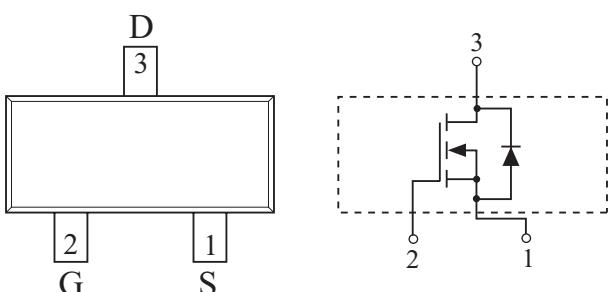
FEATURES

- $V_{DSS}=20V$, $I_D=3.6A$
- Drain-Source ON Resistance
 $R_{DS(ON)}=45m\Omega$ (Max.) @ $V_{GS}=4.5V$
 $R_{DS(ON)}=65m\Omega$ (Max.) @ $V_{GS}=2.5V$
- Super Hige Dense Cell Design

**MAXIMUM RATING (Ta=25°C)**

| CHARACTERISTIC | | SYMBOL | N-Ch | UNIT |
|---|----------|------------|-----------|------|
| Drain-Source Voltage | | V_{DSS} | 20 | V |
| Gate-Source Voltage | | V_{GSS} | ± 12 | V |
| Drain Current | DC | I_D | 3.6 | A |
| | Pulsed | I_{DP} | 14 | |
| Drain-Source-Diode Forward Current | | I_S | 1.25 | A |
| Drain Power Dissipation | $T_A=25$ | P_D | 1.25 | W |
| | $T_A=70$ | | 0.8 | |
| Maximum Junction Temperature | | T_j | 150 | |
| Storage Temperature Range | | T_{stg} | -55 ~ 150 | |
| Thermal Resistance, Junction to Ambient | | R_{thJA} | 100 | /W |

Note : Surface Mounted on FR4 Board, t = 10sec.

Marking**PIN CONNECTION (TOP VIEW)**

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ELECTRICAL CHARACTERISTICS (Ta=25 °C)

| CHARACTERISTIC | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNIT |
|---|----------------------|---|------|------|------|------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | I _{DS} =250 μA, V _{GS} =0V, | 20 | - | - | V |
| Drain Cut-off Current | I _{DS} | V _{GS} =0V, V _{DS} =16V | - | - | 1 | μA |
| Gate Leakage Current | I _{GSS} | V _{GS} =±10V, V _{DS} =0V | - | - | ±100 | nA |
| Gate Threshold Voltage | V _{th} | V _{DS} =V _{GS} , I _D =250 μA | 0.6 | 0.9 | 1.5 | V |
| Drain-Source ON Resistance | R _{DS(ON)*} | V _{GS} =4.5V, I _D =2.5A | - | 32 | 45 | m |
| | | V _{GS} =2.5V, I _D =2A | - | 50 | 65 | |
| On-State Drain Current | I _{D(ON)*} | V _{GS} =4.5V, V _{DS} =5V | 10 | - | - | A |
| Forward Transconductance | g _f * | V _{DS} =5V, I _D =3A | - | 8 | - | S |
| Dynamic | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} =15V, V _{GS} =0V, f=1MHz, | - | 437 | - | pF |
| Output Capacitance | C _{oss} | | - | 87 | - | |
| Reverse Transfer Capacitance | C _{rss} | | - | 51 | - | |
| Total Gate Charge | Q _g * | V _{DS} =10V, V _{GS} =4.5V, I _D =3.5A | - | 6.6 | - | nC |
| Gate-Source Charge | Q _{gs} * | | - | 0.8 | - | |
| Gate-Drain Charge | Q _{gd} * | | - | 1.85 | - | |
| Turn-On Delay Time | t _{d(on)*} | V _{DD} =10V, V _{GS} =4.5V I _D =1A, R _G =6 (NOTE 1) | - | 13 | - | ns |
| Turn-On Rise Time | t _r * | | - | 19 | - | |
| Turn-Off Delay Time | t _{d(off)*} | | - | 85 | - | |
| Turn-Off Fall Time | t _f * | | - | 47 | - | |
| Source-Drain Diode Ratings | | | | | | |
| Source-Drain Forward Voltage | V _{SDF*} | V _{GS} =0V, I _{DR} =1.25A | - | 0.81 | 1.2 | V |
| NOTE 1> * : Pulse Test : Pulse width <300μs , Duty cycle < 2% | | | | | | |

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Fig1. I_D - V_{DS}

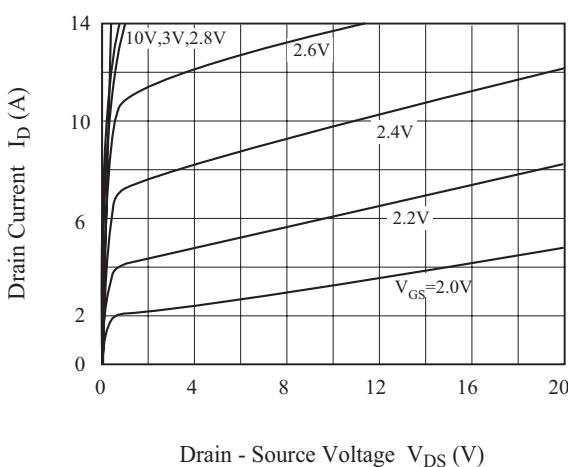


Fig2. $R_{DS(on)}$ - I_D

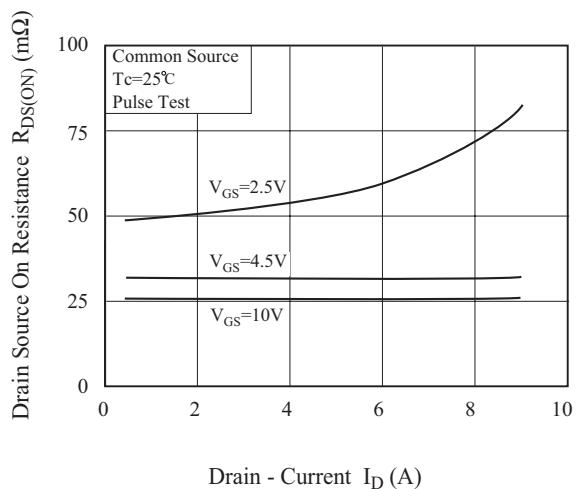


Fig3. I_D - V_{GS}

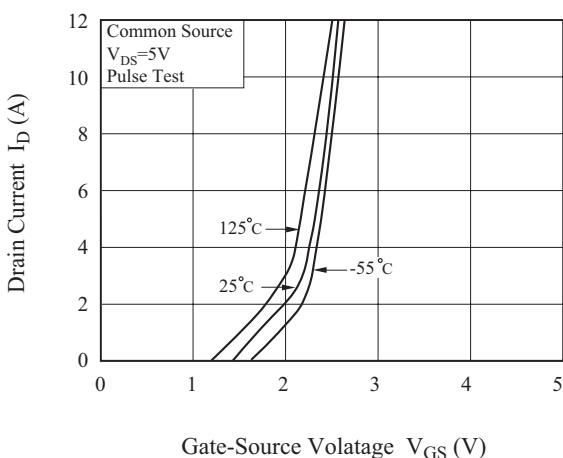


Fig4. $R_{DS(on)}$ - T_j

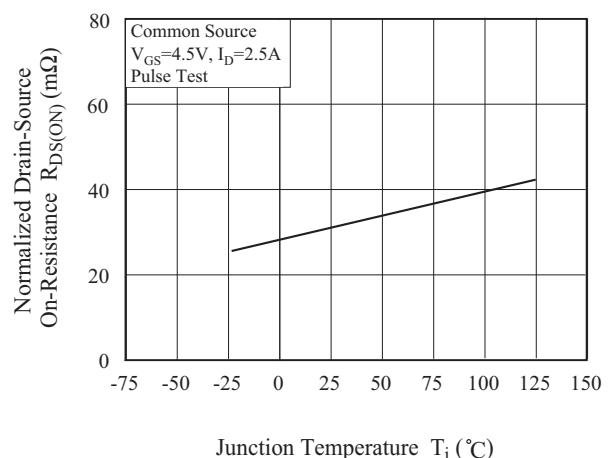


Fig5. V_{th} - T_j

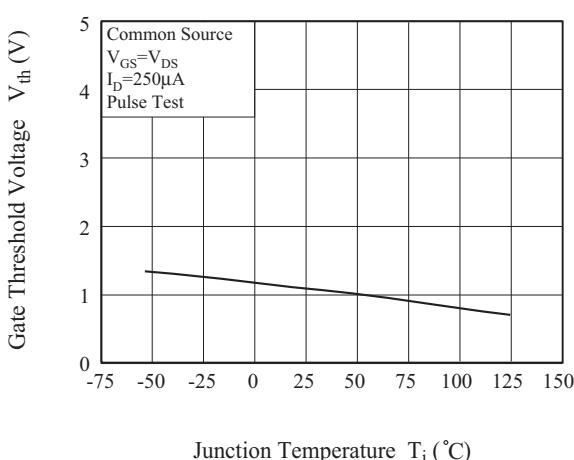
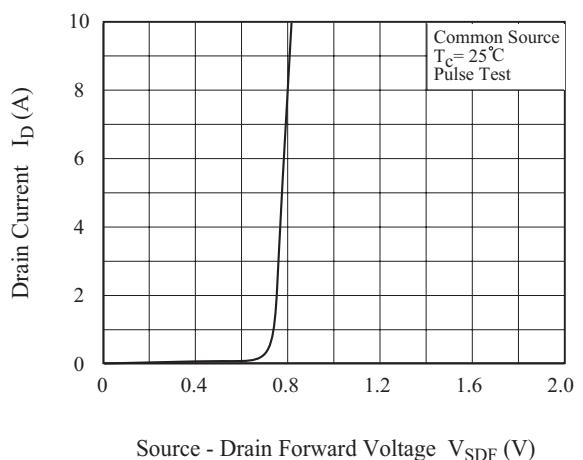


Fig6. I_S - V_{SDF}



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Fig7. Transient Thermal Response Curve

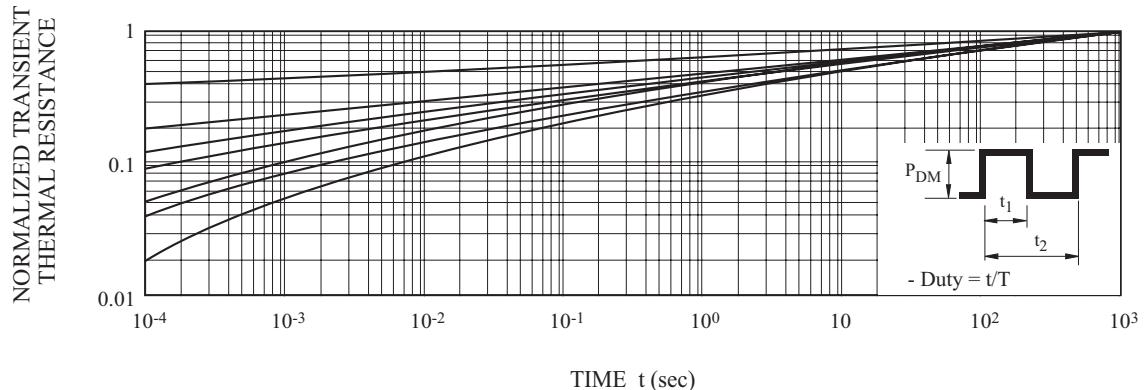
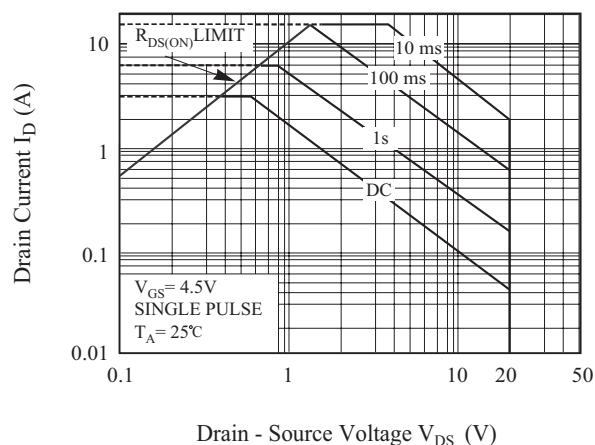


Fig8. Safe Operation Area



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Fig9. Gate Charge Circuit and Wave Form

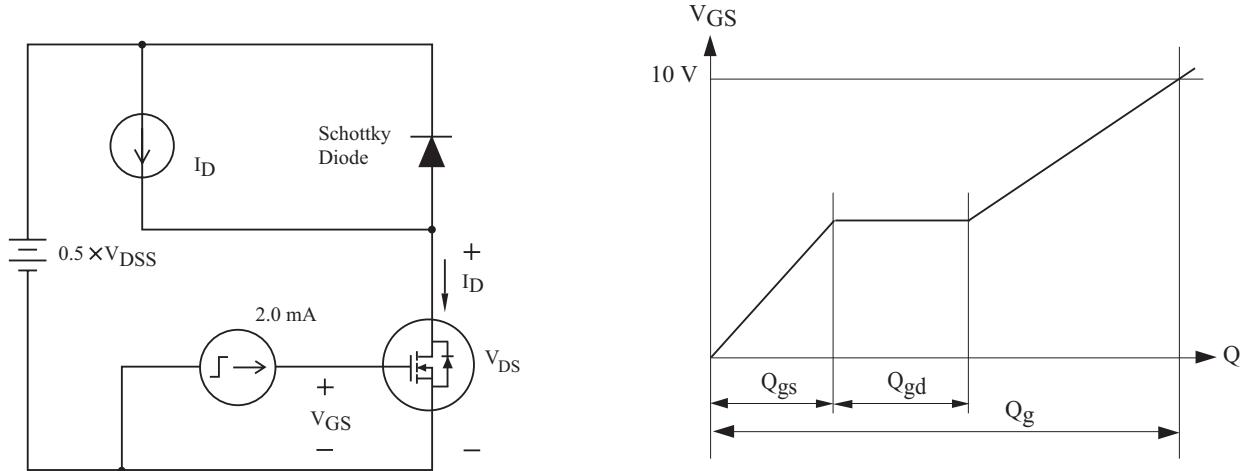


Fig10. Resistive Load Switching

